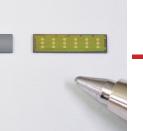


PHOTON IS OUR BUSINES

Distance linear image sensor



S15453-01WT

Back-thinned type, measures the distance to an object by TOF method

The distance image sensor is designed to measure the distance to an object by TOF (time-of-flight) method. When used in combination with a pulse modulated light source, this sensor outputs phase difference information on the timing that the light is emitted and received. Distance data can be obtained by performing calculation on the output signal with an external signal processing circuit or on a PC. We provide an evaluation kit for this product. Contact us for detailed information.

Features

- High sensitivity in the near infrared region
- Improved tolerance to background light
- Compact wafer level package (WLP) type

Applications

- → Obstacle detection (self-driving, robots, etc.)
- ⇒ Security (intrusion detection, etc.)
- **■** Shape recognition (logistics, robots, etc.)
- Motion capture
- **→** Touchless operation

Structure

Parameter	Specification	Unit
Image size	5.12 × 0.05	mm
Pixel pitch	20	μm
Pixel height	50	μm
Number of pixels	272	pixels
Number of effective pixels	256	pixels
Package	WLP	-

Note: This product is not hermetically sealed.

→ Absolute maximum ratings

Parameter		Symbol	Condition	Value	Unit
Analog supply vo	oltage	Vdd(A)	Ta=25 °C	-0.3 to +4.2	V
Digital supply vo	oltage	Vdd(D)	Ta=25 °C	-0.3 to +4.2	٧
Analan innut	Pixel amplifier	Vsf			
Analog input terminal voltage	Pixel reset	Vr	Ta=25 °C	-0.3 to Vdd(A) + 0.3	V
terrilliai voitage	Photosensitive area	1.3			
	Pixel reset pulse	pix_reset			
Disital issuet	Signal sampling pulse	phis			
Digital input	Master clock pulse Signal readout trigger pulse	mclk	Ta=25 °C	-0.3 to Vdd(D) + 0.3	V
terrilliai voitage	Signal readout trigger pulse	trig			
	Output signal sync pulse	dclk			
Charge transfer clock pulse voltage		VTX1, VTX2, VTX3	Ta=25 °C	-0.3 to Vdd(A) + 0.3	V
Operating temperature		Topr	No dew condensation*1	-25 to +85	°C
Storage tempera	Storage temperature		No dew condensation*1	-40 to +85	°C
Soldering tempe	rature* ²	Tsol		245 (twice)	°C

^{*1:} When there is a temperature difference between a product and the surrounding area in high humidity environment, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

^{*2:} Reflow soldering, IPC/JEDEC J-STD-020 MSL 2, see P.9

₽ Recommended terminal voltage (Ta=25 °C)

Parameter		Symbol	Min.	Тур.	Max.	Unit	
Analog supply voltage		Vdd(A)	3.2	3.3	3.4	V	
Digital supply voltage		Vdd(D)	3.2	3.3	3.4	V	
	Pixel amplifier	Vsf	-	Vdd(A)	-	V	
Bias voltage	Pixel reset	Vr	2.5	2.6	2.7	V	
	Photosensitive area	Vpg	0.6	0.8	1.0	V	
Divel reset pulse veltage	High level	niv rocat	$Vdd(D) \times 0.8$	-	-	V	
Pixel reset pulse voltage	Low level	pix_reset	-	-	$Vdd(D) \times 0.2$	V	
Signal sampling pulse	High level	phis	$Vdd(D) \times 0.8$	-	-	V	
voltage	Low level	priis	-	-	$Vdd(D) \times 0.2$		
Master clock pulse voltage	High level	mclk	$Vdd(D) \times 0.8$	-	<u>-</u>	V	
Master Clock pulse voltage	Low level	HICK	-	-	$Vdd(D) \times 0.2$]	
Signal readout trigger	High level	tuia	$Vdd(D) \times 0.8$	-	-	\/	
pulse voltage	Low level	trig	-	-	$Vdd(D) \times 0.2$] V	
Output signal sync pulse	High level	dclk	$Vdd(D) \times 0.8$	-	-	\ \/	
	Low level	ucik	-	-	$Vdd(D) \times 0.2$] v	

■ Electric characteristics [Ta=25 °C, Vdd(A)=Vdd(D)=3.3 V]

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Clock pulse frequency	f(mclk)		1 M	-	5 M	Hz
Data rate	DR		-	f(mclk)	-	Hz
Current consumption	Ic	Dark state	-	12	-	mA

E Electrical and optical characteristics [Ta=25 °C, Vdd(A)=Vdd(D)=3.3 V, Vsf=3.3 V, Vr=2.6 V, MCLK=5 MHz]

Parameter	Symbol	Min.	Тур.	Max.	Unit
Spectral response range	λ		nm		
Peak sensitivity wavelength	λр	-	800	-	nm
Photosensitivity*3	S	-	1.4×10^{12}	-	V/W·s·m ²
Dark output	Vd	-	2.8	-	V/s
Random noise	RN	-	0.5	-	mV rms
Dark output voltage*4	Vor	-	2.7	-	V
Sensitivity ratio*5	SR	0.7	-	1.43	-
Photoresponse nonuniformity*6	PRNU	-	-	±10	%

^{*3:} Monochromatic wavelength light source (λ =805 nm)

PRNU= $\Delta X/X \times 100$ [%]

X: average of the output of all pixel, ΔX : difference between the maximum or minimum output and X

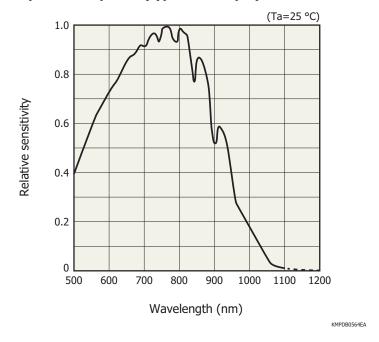


^{*4:} Output value right after reset in dark state

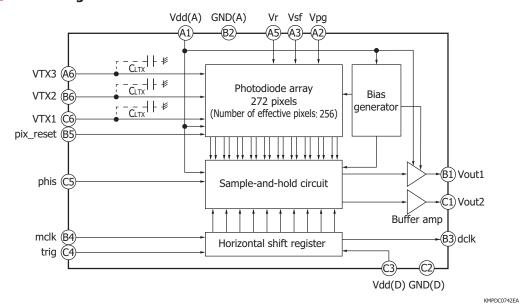
^{*5:} Output ratio of Vout1 (VTX1=1.8 V, VTX2=VTX3=0 V) to Vout2 (VTX2=1.8 V, VTX1=VTX3=0 V)

^{*6:} Photoresponse nonuniformity (PRNU) is the output nonuniformity that occurs when the entire photosensitive area is uniformly illuminated by light which is 50% of the saturation exposure level. PRNU is measured using 64 pixels excluding 8 pixels each at both ends, and is defined as follows.

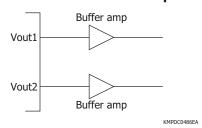
Spectral response (typical example)



Block diagram

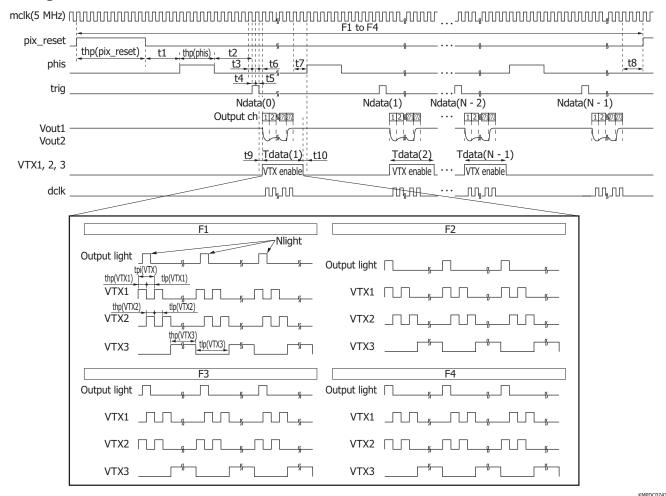


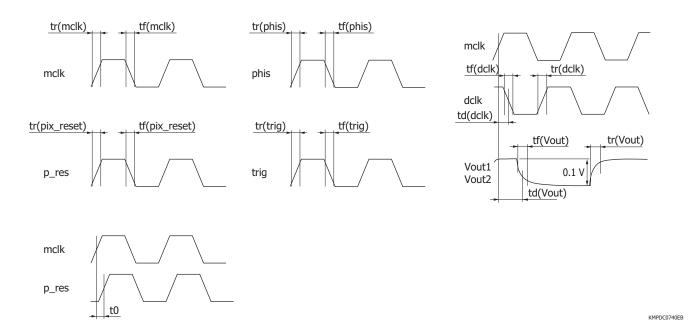
Basic connection example





- Timing chart





Calculation method of frame rate

Frame rate=1/4 of subframe time

■ If the integration time is longer than the readout time

Time per subframe=Integration time × (Non-destructive readout count - 1) + Readout time

■ If the integration time is shorter than the readout time

Time per subframe=Readout time \times Non-destructive readout time

Note: The integration time setting needs to be changed depending on the required distance accuracy and usage environment factors such as background light.

[Readout time calculation]

Readout time=
$$\frac{1}{\text{Clock pulse frequency}} \times \text{Number of horizontal pixels}$$

=Time per clock (Readout time per pixel) × Number of horizontal pixels

· Calculation example (clock pulse frequency=5 MHz, number of horizontal pixels=272)

Readout time=
$$\frac{1}{5 \times 10^6 \text{ [Hz]}} \times 272$$

=200 [ns] × 272
=0.0544 [ms]



S15453-01WT

Parameter		Symbol	Min.	Typ	Max.	Unit
Master clock pulse duty ratio		Syllibol	45	Тур. 50	55	%
Master clock pulse duty fatto Master clock pulse rise and fall times*7	tr(mclk), tf(mclk)	0	30	20		
Pixel reset pulse high period		10		- 20	ns	
Pixel reset pulse rise and fall times*7		thp(pix_reset)	0			μs
		tr(pix_reset), tf(pix_reset)		-	20	ns
Signal sampling pulse high period	47	thp(phis)	1	-	-	μs
Signal sampling pulse rise and fall time		tr(phis), tf(phis)	0	-	20	ns
Signal readout trigger pulse rise and fa		tr(trig), tf(trig)	0	-	20	ns
Time from rising edge of master clock edge of pixel reset pulse		t0	0	-	-	ns
Time from falling edge of pixel reset pu of signal sampling pulse	ılse to rising edge	t1	1	-	-	μs
Time from falling edge of signal sampli edge of signal readout trigger pulse	ng pulse to rising	t2	1.2	-	-	μs
Time from rising edge of master clock edge of signal readout trigger pulse	pulse to rising	t3	1/4 × 1/f(mclk)	-	1/2 × 1/f(mclk)	S
Time from rising edge of signal readourising edge of master clock pulse	t trigger pulse to	t4	1/4 × 1/f(mclk)	-	1/2 × 1/f(mclk)	S
Time from rising edge of master clock edge of signal readout trigger pulse	pulse to falling	t5	1/4 × 1/f(mclk)	-	1/2 × 1/f(mclk)	S
Time from falling edge of signal readourising edge of master clock pulse	it trigger pulse to	t6	1/4 × 1/f(mclk)	-	1/2 × 1/f(mclk)	S
Time from rising edge of master clock pulse (after reading signals from all pixels) to rising edge of output signal sampling pulse		t7	1/f(mclk)	-	-	S
Time from rising edge of master clock pulse (after reading signals from all pixels) to rising edge of pixel reset pulse		t8	1/f(mclk)	-	-	S
Time from rising edge of master clock pulse to falling edge of output signal sync pulse*8		td(dclk)	-	17	-	ns
Output signal sync pulse rise time*7 *8		tr(dclk)	-	20	-	ns
Output signal sync pulse fall time*7 *8		tf(dclk)	-	14	-	ns
Settling rise time of output signal 1, 2*	7 *8 *9	tr(Vout)	-	115	-	ns
Settling fall time of output signal 1, 2*7		tf(Vout)	-	115	-	ns
Time from rising edge of master clock signal 1, 2 (output 50%)*8		td(Vout)	-	55	-	ns
Charge transfer clock pulse cycle		tpi(VTX)	60	-	_	ns
change damener electrical pares cycle	High period	thp(VTX1)	30	_	_	
Charge transfer clock pulse (VTX1)	Low period	tlp(VTX1)	-	tpi(VTX) thp(VTX2) thp(VTX3)	-	ns
	High period	thp(VTX2)	30	-	-	
Charge transfer clock pulse (VTX2)	Low period	tlp(VTX2)	-	tpi(VTX) thp(VTX1) thp(VTX3)	-	ns
	High period	thp(VTX3)	0	-	-	
Charge transfer clock pulse (VTX3)	Low period	tlp(VTX3)	-	tpi(VTX) thp(VTX1) thp(VTX2)	-	ns
Charge transfer clock pulse voltage rise	and fall times*7	tr(VTX), tf(VTX)	-	3	-	ns
Charge transfer clock pulse voltage	High level Low level	VTX1, VTX2, VTX3	1.6	1.8	2.0	V
Time from falling edge of signal readoustart of VTX drive		t9	1/f(mclk)	-	-	S
Time from end of VTX drive to rising easignal sync pulse	dge of output	t10	1/f(mclk)	-	-	S
+7 +0 + 000/						



^{*7: 10} to 90%

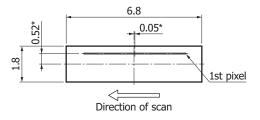
*8: Load capacitance CL=3 pF

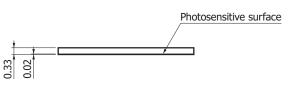
*9: Output voltage=0.1 V

Input terminal capacitance (Ta=25 °C, Vdd=3.3 V)

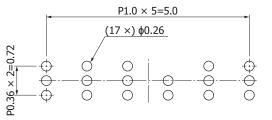
Parameter	Symbol	Min.	Тур.	Max.	Unit
Charge transfer clock pulse internal load capacitance	CLTX	-	20	-	pF

Dimensional outline (unit: mm)

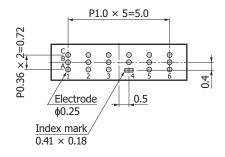




Recommended land pattern (unit: mm)



KMPDC0770EA



Tolerance unless otherwise noted: ±0.1

Au electrode

* Distance from package center to photosensitive area center

KMPDA0609EB

Pin connections

Pin no.	Symbol	I/O	Description		
A1	Vdd(A)	I	Analog supply voltage		
B1	Vout1	0	Output signal 1		
C1	Vout2	0	Output signal 2		
A2	Vpg	I	Photosensitive area bias voltage		
B2	GND(A)	I	Ground		
C2	GND(D)	I	Ground		
A3	Vsf	I	Pixel amplifier drain voltage		
B3	dclk	0	Output data sample clock		
C3	Vdd(D)	I	Digital supply voltage		
A4	NC	-	No connection		
B4	mclk	I	Master clock input signal		
C4	trig	I	Signal readout trigger signal (reset and signal level)		
A5	Vr	I	Pixel reset voltage		
B5	pix_reset	I	Pixel reset pulse		
C5	phis	I	Signal sampling signal (level determined on the falling edge)		
A6	VTX3	I	Charge transfer clock 3 (for OFD)		
В6	VTX2	I	Charge transfer clock 2		
C6	VTX1	I	Charge transfer clock 1		

Note: Leave the NC terminals open.

Connect an impedance converting buffer amplifier to Vout1 and Vout2 terminals so as to minimize the current flow.

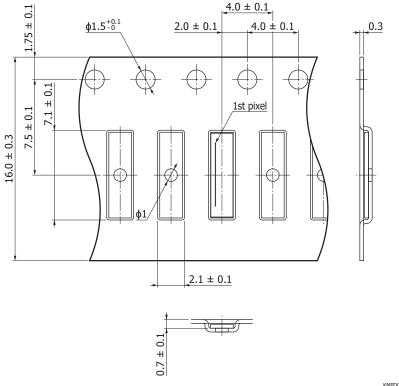


► Reel packing specifications

■ Reel (conforms to JEITA ET-7200)

Outer diameter	Hub diameter	Tape width	Material	Electrostatic characteristics
ф180 mm	ф60 mm	16 mm	PS	Conductive

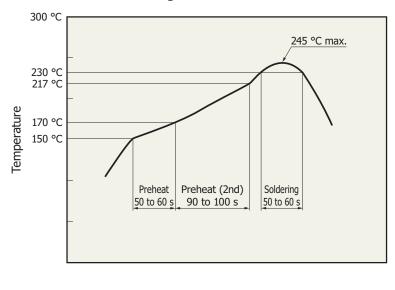
■ Embossed tape (unit: mm, material: PS, conductive)



KMPDC0827EB

- Packing quantity500 pcs/reel
- Packing state
 Reel and desiccant in moisture-proof packaging (vacuum-sealed)

Recommended soldering conditions



Time

KMPDB0584EA

- This product supports lead-free soldering. After unpacking, store it in an environment at a temperature of 30 °C or less and a humidity of 60% or less, and perform soldering within 1 year.
- The effect that the product receives during reflow soldering varies depending on the circuit board and reflow oven that are used. When you set reflow soldering conditions, check that problems do not occur in the product by testing out the conditions in advance.
- · In order to improve reliability, we recommend that you use underfill resin to fill the gap between the element and the board, after reflow soldering.

- Related information

www.hamamatsu.com/sp/ssd/doc_ja.html

- Precautions
- · Disclaimer
- · Surface mount type products
- Technical information
- · Distance image sensors (Back-thinned type) S15452/S15453/S15454-01WT

Evaluation kit for distance linear image sensor C15357

An evaluation kit [70 mm (H) × 55 mm (V)] is available for the S15453-01WT distance linear image sensor (with the S15453-01WT). Contact us for detailed information.



Information described in this material is current as of July 2020.

Product specifications are subject to change without prior notice due to improvements or other reasons. This document has been carefully prepared and the information contained is believed to be accurate. In rare cases, however, there may be inaccuracies such as text errors. Before using these products, always contact us for the delivery specification sheet to check the latest specifications.

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